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1.27MM PITCH SLIM-GRID[®] UNSHROUDED HEADERS (BOARD TO BOARD)

1.0 SCOPE

This Product Specification covers the 1.27mm centerline (pitch) printed circuit board (PCB) connector series

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER(S)

Product Name

1.27mm Pitch SLIM-GRID[®] Unshrouded Headers

Series Number

87933

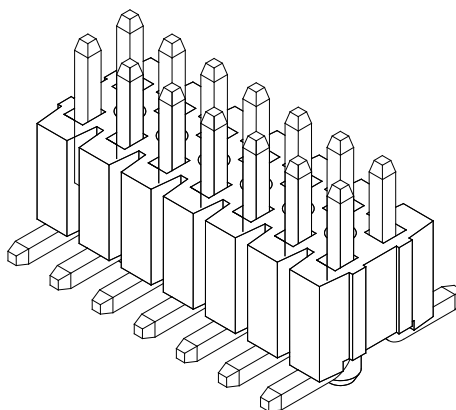
2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See Sales Drawings, SD-87933-0001, SD-87933-014, SD-87933-100 and SD-87933-101 for information on dimensions, materials, plating, and markings.

2.3 SAFETY AGENCY APPROVALS

UL FILE NUMBER : File E29179, Vol 10

CSA FILE NUMBER: 152514 (LR 19980)



3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extent specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence.

Reference Product Specifications

781200001 1.27mm Pitch SLIM-GRID[®] Vertical SMT Receptacle

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4.0 RATINGS

4.1 VOLTAGE

125 Vac

4.2 CURRENT

4.3 Amps per Pole

4.3 TEMPERATURE

Operating: - 55°C to + 105°C

Non-operating: - 55°C to + 105°C

Safety rating serves as a guideline for safe use to customer. The performance of the current and voltage rating varies at mating level. The connector must be evaluated in the customer end product for safe and proper use

5.0 PERFORMANCE

5.1 ELECTRICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Contact Resistance (LLCR)	Mate connectors: apply a maximum voltage of 20 mV and a current of 100 mA. (EIA-364-23) Note: Wire resistance and traces shall be removed from the measured value.	30 milliohms [MAXIMUM] [initial]
2	Insulation Resistance	Mated & unmount connectors: apply a voltage of 500 VDC between adjacent terminals and between terminals to ground. (EIA-364-21)	1000 Megohms [MINIMUM]
3	Dielectric Withstanding Voltage	Mated & unmount connectors: apply a voltage of 1000 VAC for 1 minute between adjacent terminals and between terminals to ground. Unmate & unmount connectors: apply a voltage of 1250 VAC for 1 minute between adjacent terminals and between terminals to ground. (EIA-364-20)	No breakdown; Current leakage < 5 mA

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4	Temperature Rise	Mate connectors at Full Loading: measure the temperature rise of the contact when 1.4A DC current is passed. (EIA-364-70, Method 1)	Temperature rise: +30°C [MAXIMUM]
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5.2 MECHANICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
5	Connector Mate & Unmate Force	Mate and unmate connectors at a rate of 25.4 mm/min. (EIA-364-13D, Method A)	Mate Force 15N (24ckt) 10N (4ckt) [MAXIMUM] Unmate Force 3.0N (24ckt) 0.5N (4ckt) [MINIMUM]
6	Durability	Mate connectors up to 50 cycles at a maximum rate of 500 ±50 cycles/hr. (EIA-364-09)	Appearance: No Damage Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]
7	Reseating	Manually mate and unmate the connector with mating half for 3 cycles with rate of 5 cycles/min maximum. (EIA-364-09)	Appearance: No Damage Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]
8	Terminal Retention Force (in Housing)	Axial pullout force on the terminal in the housing at a rate of 25 ± 6 mm (1 ± ¼ inch) per minute. (EIA-364-29, Method C)	4.0 N [MINIMUM]

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9	Vibration	<p>Mate connectors and subject to the following vibration conditions, for a period of 2 hours in each 3 mutually perpendicular axis.</p> <p>Amplitude: 1.52mm (.060 inch) peak to peak Test pulse: half sine Sweep: 10->55->10 Hz in 1 minute Duration: 2 hours in each x-y-z axis.</p> <p>(EIA-364-28, Test Condition I)</p>	<p>Appearance: No Damage</p> <p>15milliohms [MAXIMUM] (change from initial)</p> <p>Discontinuity: 1.0 μs [maximum]</p>										
10	Mechanical shock	<p>Mate connectors and subject to the following shock conditions, 3 shocks shall be applied along 3 mutually perpendicular axis. (total of 18 shocks)</p> <p>Peak value: 490 m/s sq. (50G) Test pulse : half sine Duration : 11 ms in each x-y-z axis</p> <p>(EIA-364-27B Condition A)</p>	<p>Appearance: No Damage</p> <p>Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]</p> <p>Discontinuity: 1.0 μs [maximum]</p>										
11	Thermal shock	<p>Mate connectors, expose to 5 cycles of:-</p> <table border="1" data-bbox="558 1108 1042 1373"> <thead> <tr> <th>Temperature °c</th> <th>Duration (minutes)</th> </tr> </thead> <tbody> <tr> <td>-55+0/-5</td> <td>30</td> </tr> <tr> <td>Transfer time from cold to hot</td> <td>5 maximum</td> </tr> <tr> <td>+105+3/-0</td> <td>30</td> </tr> <tr> <td>Transfer time from hot to cold</td> <td>5 maximum</td> </tr> </tbody> </table> <p>(EIA-364-32G Method A, Condition VII)</p>	Temperature °c	Duration (minutes)	-55+0/-5	30	Transfer time from cold to hot	5 maximum	+105+3/-0	30	Transfer time from hot to cold	5 maximum	<p>Appearance: No Damage</p> <p>Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]</p>
Temperature °c	Duration (minutes)												
-55+0/-5	30												
Transfer time from cold to hot	5 maximum												
+105+3/-0	30												
Transfer time from hot to cold	5 maximum												
12	Temperature life	<p>Mate connectors, expose to:-</p> <p>Temperature: 105 ± 2 °c Duration: 96 hours.</p> <p>(EIA-364-17, Method A, Condition 4)</p>	<p>Appearance: No Damage</p> <p>Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]</p>										

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13	Cyclic temperature and humidity	<p>Mate connector and expose to:-</p> <p>Temperature: 25 ± 3 °C @ Humidity: 80% ± 3% And Temperature: 65 ± 3 °C @ Humidity: 50% ± 3% Ramp times should be 0.5 hour and dwell times should be 1.0 hour. Dwell times start when the temperature and humidity have stabilized within the specified levels. Duration: 24 cycles (72 hours)</p>	<p>Appearance: No Damage</p> <p>Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]</p> <p>Dielectric withstanding Voltage: No breakdown</p> <p>Insulation resistance: 1000 megaΩ minimum</p>
14	Low temperature test	<p>Mate connectors and expose to:</p> <p>Temperature: -40 ± 3°C Duration: 96 +5/-0 hours (EIA-364-59A)</p>	<p>Appearance: No Damage</p> <p>Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]</p>
15	SO₂ gas (gold plated only)	<p>Mate connectors and expose to:</p> <p>SO₂ gas density: 50 ±5 ppm Temperature: 40 ±2 °C Duration: 24 hours Humidity: 60-75%.</p>	<p>Appearance: No Damage</p> <p>Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]</p>
16	Salt spray	<p>Expose the mated connectors to the following salt mist condition:</p> <p>Concentration : 5 ±1% Temperature : 35 +1/-2°C Test time : 48 hours</p> <p>(note: immediately after exposure, the test specimens shall be dipped in running tap (≤38°C) for 5 mins max and dried for 16 hour max in a circulating air oven at 38 ± 3°C. Sample examination done in room temperature.</p> <p>(EIA-364-26C, Condition B)</p>	<p>Appearance: No Damage</p> <p>Contact Resistance: 15milliΩ [MAXIMUM] [CHANGE FROM INITIAL]</p>

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17	Solderability	<p>Unmate connector.</p> <p>Steam age for 8 hour ± 15 min. (precondition: Condition C)</p> <p>SMT Surface mount process simulation test Solder paste is deposited onto screen (e.g.ceramic plate) via stencil. The connectors are placed onto the solder paste print. Subject the substrate and component to the reflow process through a convection oven. Refer to section 8.0 for temperature profile. Flux type: ROLO</p>	95% of the immersed area must show no voids, pin holes
18	Resistance to solder Heats	<p>SMT Convection reflow Sample to be passed through reflow over according to temperature profiles (shown in section 8.0)</p> <p>(EIA-364-56C, Procedure 6)</p>	Appearance: no damage

6.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage. Refer to Packaging Specification, PK-87933-565 AND PK-87933-300

7.0 OTHERS

Although some discolouration could be seen on the soldertail after reflow, it does not impact on the product's performance.

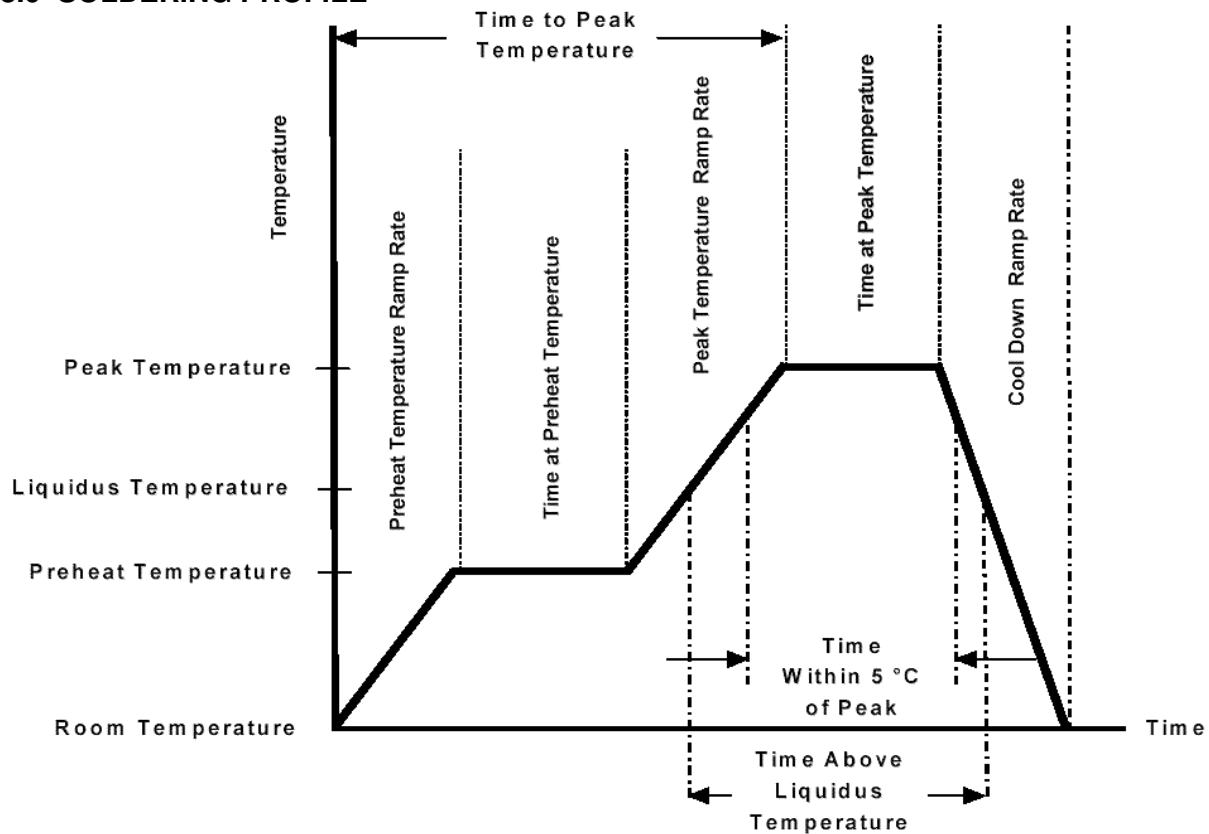
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7.0 TEST SEQUENCES

Sequential Tests Group →	1	2	3	4	5	6	7	8	9	10	11
Test or Examination ↓											
Sample size	5	5	5	5	5	5	5	5	5	5	5
Resistance to Soldering Conditions	1	1	1	1	1	1	1	1			
Low Level Contact Resistance (LLCR)	2, 5, 7	2, 5, 7, 9	2, 5, 7, 9		2, 4	2, 4	2, 4	3, 7			
Insulation Resistance				2, 6							
Dielectric Withstanding Voltage				3, 7							
Connector Mate								2, 6			
Connector Unmate								4, 8			
Durability	3(a)	3(a)	3(a)					5			
Reseating	6	8									
Vibration			6								
Mechanical Shock			8								
Thermal Shock		4		4							
Temperature Life	4		4(a)								
Cyclic Temperature & Humidity		6		5							
Low Temperature Test					3						
SO ₂ gas (Gold plated)						3					
Salt Spray							3				
Pin Retention (in housing)									1		
Solderability										1	
Temperature Rise											1

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8.0 SOLDERING PROFILE



Description	Requirement
Average Ramp Rate	3°C/sec Max
Preheat Temperature	150°C Min to 200°C Max
Preheat Time	60 to 180 sec
Ramp to Peak	3°C/sec Max
Time over Liquidus (217°C)	60 to 150 sec Max
Peak Temperature	260 +0/-5°C
Time within 5°C of Peak	20 to 40 sec
Ramp - Cool Down	6°C/sec Max
Time 25 °C to Peak	8 Min Max

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